

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM139AD	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-55 to 125	LM139A
LM139ADG4	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-55 to 125	LM139A
LM139ADR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LM139A
LM139ADRG4	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LM139A
LM139D	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-55 to 125	LM139
LM139DG4	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-55 to 125	LM139
LM139DR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LM139
LM139DRG4	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LM139
LM239AD	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-25 to 85	LM239A
LM239ADR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM239A
LM239D	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-25 to 85	LM239
LM239DR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU   SN	Level-1-260C-UNLIM	-25 to 85	LM239
LM239N	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU   SN	N/A for Pkg Type	-25 to 85	LM239N
LM239PW	Obsolete	Production	TSSOP (PW)   14	-	-	Call TI	Call TI	-25 to 85	L239
LM239PWR	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	L239
LM239PWRG4	Obsolete	Production	TSSOP (PW)   14	-	-	Call TI	Call TI	-25 to 85	L239
LM2901AVQDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(2901AV, L2901AV)
LM2901AVQDRG4	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(2901AV, L2901AV)
LM2901AVQPWR	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(2901AV, L2901AV)
LM2901AVQPWRG4	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(2901AV, L2901AV)
LM2901BIDR	Active	Production	SOIC (D)   14	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2901B
LM2901BIPWR	Active	Production	TSSOP (PW)   14	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2901B
LM2901BIRTER	Active	Production	WQFN (RTE)   16	5000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	M2901B
LM2901D	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-40 to 125	LM2901
LM2901DR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 125	LM2901
LM2901DRE4	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2901
LM2901DRG3	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	LM2901
LM2901DRG4	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2901
LM2901N	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 125	LM2901N

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM2901NSR	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2901
LM2901PW	Obsolete	Production	TSSOP (PW)   14	-	-	Call TI	Call TI	-40 to 125	L2901
LM2901PWR	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2901
LM2901PWRG3	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	L2901
LM2901PWRG4	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2901
LM2901VQDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2901V
LM2901VQPWR	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2901V
LM2901VQPWRG4	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2901V
LM339AD	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	0 to 70	LM339A
LM339ADBR	Active	Production	SSOP (DB)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	L339A
LM339ADR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU   SN	Level-1-260C-UNLIM	0 to 70	LM339A
LM339ADRG4	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	0 to 70	LM339A
LM339AN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU   SN	N/A for Pkg Type	0 to 70	LM339AN
LM339ANSR	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM339A
LM339APW	Obsolete	Production	TSSOP (PW)   14	-	-	Call TI	Call TI	0 to 70	L339A
LM339APWR	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	L339A
LM339APWRG4	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	L339A
LM339BIDR	Active	Production	SOIC (D)   14	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM339B
LM339BIPWR	Active	Production	TSSOP (PW)   14	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM339B
LM339BIRTER	Active	Production	WQFN (RTE)   16	5000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LM339B
LM339D	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	0 to 70	LM339
LM339DBR	Active	Production	SSOP (DB)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM339
LM339DR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU   SN	Level-1-260C-UNLIM	0 to 70	LM339
LM339DRE4	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM339
LM339DRG4	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM339
LM339N	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU   SN	N/A for Pkg Type	0 to 70	LM339N
LM339NE3	Active	Production	PDIP (N)   14	25   TUBE	Yes	SN	N/A for Pkg Type	0 to 70	LM339N
LM339NE4	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	LM339N
LM339NSR	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM339
LM339PW	Obsolete	Production	TSSOP (PW)   14	-	-	Call TI	Call TI	0 to 70	L339
LM339PWR	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU   SN	Level-1-260C-UNLIM	0 to 70	L339

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM339PWRE4	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	L339
<a href="#">LM339PWRG3</a>	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	L339
<a href="#">LM339PWRG4</a>	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	L339

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF LM139, LM239A, LM2901, LM2901AV, LM2901B, LM2901V :**

● Automotive : [LM239A-Q1](#), [LM2901-Q1](#), [LM2901AV-Q1](#), [LM2901B-Q1](#), [LM2901V-Q1](#)

● Enhanced Product : [LM239A-EP](#)

- Space : [LM139-SP](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application